DRAFT INDIAN STANDARD IN WIDE CIRCULATION

Reference: T-34 Date: 19 June 2024

TECHNICAL COMMITTEE: Winding Wire, ETD 33

To,

All concerned

Dear Madam/Sir,

The following document has been prepared by the Winding Wire Sectional Committee, ETD 33. Please <u>click here</u> to view the document.

Document Number: ETD 33 (25296) WC

Title of the document: Specifications for particular types of winding wires - Part 2: Solderable polyurethane

enamelled round copper wire class 130 with a bonding layer

Document Type: Revision of Indian Standard (IS 13730: Part 2: 2018)

This document has following salient features which may require specific attention for your valuable comments:

1) IEC 60317-2:2019 specifies the requirements of solderable enamelled round copper winding wire of class 130 with a dual coating. The underlying coating is based on polyurethane resin, which may be modified providing it retains the chemical identity of the original resin and meets all specified wire requirements. The superimposed coating is a bonding layer based on a thermoplastic resin.

Please examine the document and share your comments regarding further improvement in the document.

Last date for sharing the comments is: 19 July 2024

The comments should be shared in the prescribed template through this portal only; and the comments so received shall be taken up by the Sectional Committee for necessary action. For any other query, please write an email at eetd@bis.gov.in to the undersigned at Bureau of Indian Standard, Manak Bhawan, 9, Bahadur Shah Zafar Marg, New Delhi.

In case no comments are received, we would presume your approval of the documents. However, in case we receive any comments on the document, the same shall be put up to the Sectional Committee for necessary action.

Thanking You,

Yours faithfully, (ASIT KUMAR MAHARANA) Head (Electrotechnical Department) Email: eetd@bis.gov.in

व्यापक परिचालन में मसौदा(दे)

हमारा सन्दर्भ : T-34 दिनांक : 19-06-2024

तकनीकी समिति: Winding Wire Sectional Committee, ETD 33

प्राप्तकर्ता: रूचि रखने वाले सभी निकाय

महोदय/या,

निम्नलिखित मसौदा तैयार किया गया है:

प्रलेख संख्या: ETD 33 (25296) WC

शीर्षक:

कृपया इस/इन मानक(को)/संसोधन(नो) के मसौदे(दो) का अवलोकन करें और अपनी सम्मतियाँ यह बताते हुए भेजें कि यदि ये मानक(को) के संशोधन(नो) के रूप में प्रकाशित हो तो इन पर अमल करने में आपके व्यवसाय अथवा कारोबार में क्या कठिनाइयां आ सकती हैं।

सम्मत्तियाँ भेजने की अंतिम तिथि: 19 July 2024

सम्मतियाँ, यदि कोई हों तो, कृपया यहाँ क्लिक करके ऑनलाइन पोर्टल के माध्यम से ऊपर दी गयी अंतिम तिथि तक दर्ज कराएं।

यह/ये प्रलेख भारतीय मानक ब्यूरो की वेबसाइट www.bis.gov.in पर भी उपलब्ध है/हैं।

धन्यवाद।

भवदीय/भवदिया,

विभाग प्रमुख का नाम : ASIT KUMAR MAHARANA

(Electrotechnical Department)

ई-मेल: eetd@bis.gov.in